

YON, et al.
Preliminary Amendment
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from one another.

32. (New) Process according to claim 31 in which the material with low thermal conductivity is silicon nitride or polymer material.

REMARKS

After entry of this amendment, claims 17 – 32 are pending in the application. Claims 1 – 16 have been cancelled without prejudice. Claims 17 – 32 have been added in this amendment.

It is submitted that this Amendment has antecedent basis in the application as originally filed, including the specification, claims and drawings, and that this amendment does not add any new subject matter to the application. Consideration of the application as amended is requested. It is submitted that this Amendment places the application in suitable condition for allowance; notice of which is requested.

If the Examiner feels that prosecution of the present application can be expedited by way of an Examiner's amendment, the Examiner is invited to contact the Applicants' attorney at the telephone number listed below.

Respectfully submitted,

Dated: 16 July 2001

By: 

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